

## 3A, 50V - 600V Surface Mount Super Fast Rectifier

#### **FEATURES**

- · Glass passivated chip junction
- Ideal for automated placement
- Super fast recovery time for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication.

M	Œ	CI	ΔI	u	C	Δ		n	Λ	T	Δ
		•	_			_	_	_	_		_

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.21 g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I <sub>F(AV)</sub>	3	А				
$V_{RRM}$	50 - 600	V				
I <sub>FSM</sub>	100	А				
$T_{JMAX}$	150	°C				
Package	DO-214AB (SMC)					
Configuration	Single die					





**DO-214AB (SMC)** 

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)										
PARAMETER	SYMBOL	ES3A	ES3B	ES3C	ES3D	ES3F	ES3G	ES3H	ES3J	UNIT
Marking code on the device		ES3A	ES3B	ES3C	ES3D	ES3F	ES3G	ES3H	ES3J	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	300	400	500	600	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	105	140	210	280	350	420	V
Maximum DC blocking voltage	$V_{DC}$	50	100	150	200	300	400	500	600	V
Forward current	I <sub>F(AV)</sub>				;	3				Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub> 100				А					
Junction temperature	T <sub>J</sub> - 55 to +150			°C						
Storage temperature	T <sub>STG</sub>		•	•	- 55 to	+150				°C



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance per diode	$R_{\Theta JL}$	12	°C/W
Junction-to-ambient thermal resistance per diode	$R_{\Theta JA}$	47	°C/W

PARAMETER		CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
<b>F</b>	ES3A ES3B ES3C ES3D	L 04 T 0500	.,	-	0.95	V
Forward voltage per diode (1)	ES3F ES3G	$I_F = 3A, T_J = 25^{\circ}C$	V <sub>F</sub>	-	1.30	V
	ES3H ES3J			-	1.70	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>		T <sub>J</sub> = 25°C		-	10	μA
		T <sub>J</sub> = 100°C	- I <sub>R</sub>	-	500	μΑ
ES3A ES3B ES3C ES3D		4 MH= V 4 0V		45	-	pF
Junction capacitance	ES3F ES3G ES3H ES3J	1 MHz, V <sub>R</sub> =4.0V	C <sub>J</sub>	30	-	pF
Reverse recovery time		I <sub>F</sub> =0.5A , I <sub>R</sub> =1.0A I <sub>RR</sub> =0.25A	t <sub>rr</sub>	-	35	ns

2

### Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms





ORDERING INFORMATION							
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
		R7		SMC	850 / 7" Plastic reel		
		R6	G	SMC	3,000 / 13" Paper reel		
ES3x (Note 1,2)	Н	M6		SMC	3,000 / 13" Plastic reel		
(Note 1,2)		V7		Matrix SMC	850 / 7" Plastic reel		
		V6		Matrix SMC	3,000 / 13" Plastic reel		

### Note:

- 1. "x" defines voltage from 50V (ES3A) to 600V (ES3J)
- 2. Only V6 and V7 are all green compound (halogen free)

EXAMPLE							
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION		
ES3AHR7G	ES3A	Н	R7	G	AEC-Q101 qualified Green compound		



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

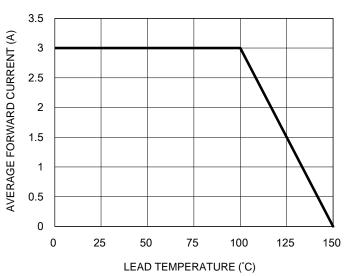


Fig.2 Typical Junction Capacitance

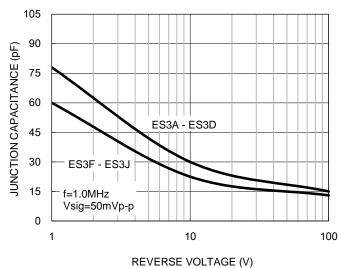


Fig.3 Typical Reverse Characteristics

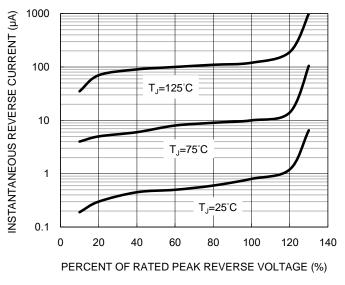
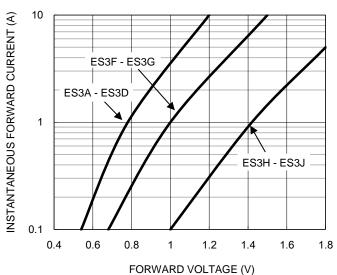


Fig.4 Typical Forward Characteristics



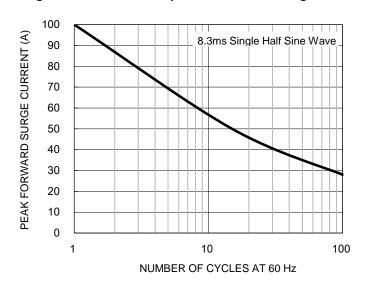
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#### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current



**Fig.6 Typical Transient Thermal Characteristics** 

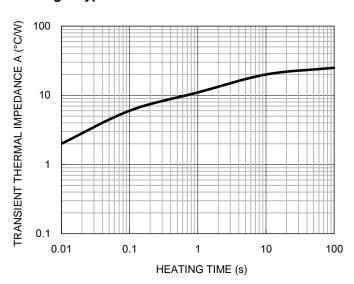
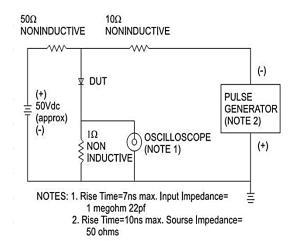
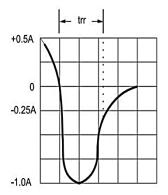


Fig.7 Reverse Recovery Time Characteristic And Test Circuit Diagram



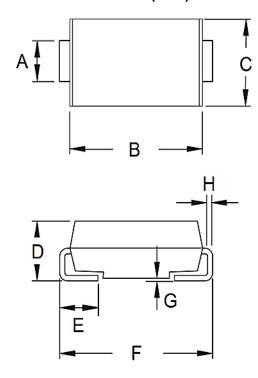


5



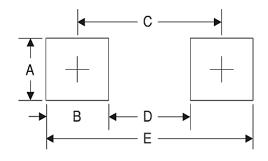
## **PACKAGE OUTLINE DIMENSIONS**

### DO-214AB (SMC)



DIM.	Unit (		Unit (	(inch)
DIN.	Min.	Max.	Min.	Max.
А	2.90	3.20	0.114	0.126
В	6.60	7.11	0.260	0.280
С	5.59	6.22	0.220	0.245
D	2.00	2.62	0.079	0.103
Е	1.00	1.60	0.039	0.063
F	7.75	8.13	0.305	0.320
G	0.10	0.20	0.004	0.008
Н	0.15	0.31	0.006	0.012

# SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	3.30	0.130
В	2.50	0.098
С	6.80	0.268
D	4.40	0.173
Е	9.40	0.370

### **MARKING DIAGRAM**

### **Matrix SMC**







P/N =Marking Code

G =Green Compound

YW =Date Code F =Factory Code

6 Version:M1903



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7